



# SLOVENSKI STANDARD

## SIST EN 61375-3-1:2012

01-oktober-2012

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**Železniške elektronske naprave - Komunikacijsko omrežje vlaka - 3-1. del: MVB - Večnamensko podatkovno vodilo vozila (IEC 61375-3-1:2012)**

Electronic railway equipment - Train communication network - Part 3-1: MVB - Multipurpose Vehicle Bus (IEC 61375-3-1:2012)

Elektronische Betriebsmittel für Bahnen - Zug-Kommunikations-Netzwerk - Teil 3-1: Multipurpose Vehicle Bus (MVB) (IEC 61375-3-1:2012)

Matériel électronique ferroviaire - Réseau embarqué de train (TCN) - Partie 3-1: Bus de véhicule multifonctions (MVB) (CEI 61375-3-1:2012)

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**Ta slovenski standard je istoveten z: EN 61375-3-1:2012**

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EUROPEAN STANDARD  
NORME EUROPÉENNE  
EUROPÄISCHE NORM

**EN 61375-3-1**

August 2012

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English version

**Electronic railway equipment -  
Train communication network (TCN) -  
Part 3-1: Multifunction Vehicle Bus (MVB)  
(IEC 61375-3-1:2012)**

Matériel électronique ferroviaire -  
Réseau embarqué de train (TCN) -  
Partie 3-1: Bus de Véhicule Multifonctions  
(MVB)  
(CEI 61375-3-1:2012)

Elektronische Betriebsmittel für Bahnen -  
Zug-Kommunikations-Netzwerk -  
Teil 3-1: Multipurpose Vehicle Bus (MVB)  
(IEC 61375-3-1:2012)

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This European Standard was approved by CENELEC on 2012-07-26. CENELEC members are bound to comply with the CEN/CENELEC Internal Regulations which stipulate the conditions for giving this European Standard the status of a national standard without any alteration.

Up-to-date lists and bibliographical references concerning such national standards may be obtained on application to the CEN-CENELEC Management Centre or to any CENELEC member.

This European Standard exists in three official versions (English, French, German). A version in any other language made by translation under the responsibility of a CENELEC member into its own language and notified to the CEN-CENELEC Management Centre has the same status as the official versions.

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European Committee for Electrotechnical Standardization  
Comité Européen de Normalisation Electrotechnique  
Europäisches Komitee für Elektrotechnische Normung

**Management Centre: Avenue Marnix 17, B - 1000 Brussels**

## Foreword

The text of document 9/1644/FDIS, future edition 1 of IEC 61375-3-1, prepared by IEC/TC 9 "Electrical equipment and systems for railways" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN 61375-3-1:2012.

The following dates are fixed:

- latest date by which the document has to be implemented at national level by publication of an identical national standard or by endorsement (dop) 2013-04-26
- latest date by which the national standards conflicting with the document have to be withdrawn (dow) 2015-07-26

Attention is drawn to the possibility that some of the elements of this document may be the subject of patent rights. CENELEC [and/or CEN] shall not be held responsible for identifying any or all such patent rights.

This document has been prepared under a mandate given to CENELEC by the European Commission and the European Free Trade Association, and supports essential requirements of EU Directive(s).

For the relationship with EU Directive(s) see informative Annex ZZ, which is an integral part of this document.

SIST EN 61375-3-1:2012  
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The text of the International Standard IEC 61375-3-1:2012 was approved by CENELEC as a European Standard without any modification.

In the official version, for Bibliography, the following notes have to be added for the standards indicated:

IEC 60332-1-2	NOTE	Harmonized as EN 60332-1-2.
IEC 60870 series	NOTE	Harmonized in EN 60870 series.
IEC 61158-2	NOTE	Harmonized as EN 61158-2.

## Annex ZA (normative)

### Normative references to international publications with their corresponding European publications

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE When an international publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 60245-1	-	Rubber insulated cables - Rated voltages up to and including 450/750 V - Part 1: General requirements	-	-
IEC 60304	-	Standard colours for insulation for low-frequency cables and wires	HD 402 S2	-
IEC 60332-1-1	-	Tests on electric and optical fibre cables under fire conditions - Part 1-1: Test for vertical flame propagation for a single insulated wire or cable - Apparatus	EN 60332-1-1	-
IEC 60571	-	Electronic equipment used on rail vehicles	-	-
IEC 60794-1-1	-	Optical fibre cables - Part 1-1: Generic specification - General	EN 60794-1-1	-
IEC 60807	Series	Rectangular connectors for frequencies below 3 MHz	-	-
IEC 60870-5-1	-	Telecontrol equipment and systems - Part 5: Transmission protocols - Section 1: Transmission frame formats	EN 60870-5-1	-
IEC 61375-2-1	-	Electronic railway equipment - Train communication network (TCN) - Part 2-1: Wire Train Bus (WTB)	EN 61375-2-1	-
ISO/IEC 8482	-	Information technology - Telecommunications - and information exchange between systems - Twisted pair multipoint interconnections	-	-
ISO/IEC 8802-2	-	Information technology - Telecommunications - and information exchange between systems - Local and metropolitan area networks - Specific requirements - Part 2: Logical link control	-	-
ISO/IEC 8824	Series	Information technology - Abstract Syntax Notation One (ASN.1)	-	-
ISO/IEC 8825	Series	Information technology - ASN.1 encoding rules	-	-
ISO/IEC 9646	Series	Information technology - Open Systems Interconnection - Conformance testing methodology and framework	-	-
ISO/IEC 13239	-	Information technology - Telecommunications - and information exchange between systems - High-level data link control (HDLC) procedures	-	-

EN 61375-3-1:2012

- 4 -

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
ITU-T Recommendation Z.100	-	Specification and Description Language (SDL)-	-	-

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**Annex ZZ**  
(informative)

**Coverage of Essential Requirements of EU Directives**

This European Standard has been prepared under a mandate given to CENELEC by the European Commission and the European Free Trade Association and within its scope the standard covers all relevant essential requirements as given in Annex III of the EU Directive 2008/57/EC.

Compliance with this standard provides one means of conformity with the specified essential requirements of the Directive concerned.

WARNING: Other requirements and other EU Directives may be applicable to the products falling within the scope of this standard.

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IEC 61375-3-1

Edition 1.0 2012-06

# INTERNATIONAL STANDARD

## NORME INTERNATIONALE

**Electronic railway equipment – Train communication network (TCN) –  
Part 3-1: Multifunction Vehicle Bus (MVB)**

**Matériel électronique ferroviaire – Réseau embarqué de train (TCN) –  
Partie 3-1: Bus de Véhicule Multifonctions (MVB)**

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## CONTENTS

FOREWORD.....	8
INTRODUCTION.....	10
1 Scope.....	12
2 Normative references.....	12
3 Terms and definitions, abbreviations and conventions.....	13
3.1 Terms and definitions.....	13
3.2 Abbreviations.....	30
3.3 Conventions.....	31
3.3.1 Base of numeric values.....	31
3.3.2 Naming conventions.....	32
3.3.3 Time naming conventions.....	32
3.3.4 Procedural interface conventions.....	32
3.3.5 Specification of transmitted data.....	35
3.3.6 State diagram conventions.....	37
4 Physical Layer.....	38
4.1 Topology.....	38
4.1.1 Segments.....	38
4.1.2 Couplers.....	38
4.1.3 Double-line segments.....	39
4.2 Device classes.....	39
4.2.1 Capabilities.....	39
4.2.2 Class 0 devices.....	40
4.2.3 Class 1 devices.....	40
4.2.4 Class 2 devices.....	40
4.2.5 Class 3 devices.....	40
4.2.6 Class 4 devices.....	40
4.2.7 Class 5 devices.....	40
4.2.8 Device Attachment.....	41
4.3 Specifications common to all media.....	41
4.3.1 Signalling speed.....	41
4.3.2 Propagation delays.....	41
4.3.3 Transceiver interface.....	41
4.3.4 Redundant medium (option).....	42
4.4 Electrical Short Distance medium (choice).....	43
4.4.1 ESD topology.....	43
4.4.2 ESD configuration rules.....	44
4.4.3 ESD section specifications.....	45
4.4.4 ESD shielding.....	45
4.4.5 ESD medium-dependent interface.....	46
4.4.6 ESD Line_Unit specifications.....	48
4.4.7 ESD signal wave form.....	48
4.4.8 ESD transmitter.....	49
4.4.9 ESD receiver.....	50
4.5 Electrical Middle Distance medium (choice).....	51
4.5.1 EMD topology.....	51
4.5.2 EMD configuration rules.....	51

4.5.3	EMD terminator.....	52
4.5.4	Cable section.....	52
4.5.5	EMD shielding.....	53
4.5.6	EMD medium-dependent interface .....	54
4.5.7	EMD Line_Unit specifications.....	57
4.5.8	EMD signal waveform .....	58
4.5.9	EMD transmitter specifications.....	58
4.5.10	EMD receiver specifications .....	62
4.6	Optical Glass Fibre medium (choice).....	63
4.6.1	OGF topology .....	64
4.6.2	OGF optical cable and fibre.....	64
4.6.3	OGF medium-dependent interface .....	64
4.6.4	OGF test signal (guideline) .....	65
4.6.5	OGF transmitter specifications .....	66
4.6.6	OGF receiver specifications .....	66
4.6.7	OGF active star coupler .....	67
4.6.8	OGF double-line layout (option).....	68
5	Medium-dependent signalling.....	68
5.1	Frame encoding and decoding .....	68
5.1.1	Conventions.....	68
5.1.2	Bit encoding.....	69
5.1.3	Non-data symbols.....	69
5.1.4	Start Bit .....	69
5.1.5	Start Delimiter.....	69
5.1.6	End Delimiter.....	70
5.1.7	Valid frame (definition).....	71
5.1.8	Detection of line idle .....	71
5.1.9	Detection of collision.....	71
5.1.10	Receiver behaviour in case of error.....	71
5.1.11	Jabber halt .....	71
5.2	Line redundancy (option) .....	72
5.2.1	Principle .....	72
5.2.2	Redundant transmission.....	72
5.2.3	Redundant reception.....	72
5.2.4	Switchover.....	72
5.2.5	Redundancy status report .....	73
5.3	Repeater .....	73
5.3.1	Repeater between single-line segments .....	74
5.3.2	Repeater for redundant medium (option) .....	74
6	Frames and telegrams .....	75
6.1	Frame format.....	75
6.1.1	Master Frame format .....	75
6.1.2	Slave Frame format .....	75
6.1.3	Check Sequence.....	76
6.2	Telegram timing.....	77
6.2.1	Conventions.....	77
6.2.2	Reply delay (definition).....	77
6.2.3	Frame spacing at the source.....	79
6.2.4	Frame spacing at the destination.....	79

6.2.5	Frame spacing at the master .....	80
6.3	Detection of correct frames, collision and silence by the master .....	81
6.3.1	Correct frame (definition) .....	81
6.3.2	Detection of collision by the master .....	81
6.3.3	Detection of silence by the master .....	81
7	Link Layer Control .....	81
7.1	Addressing .....	81
7.1.1	Device Address .....	81
7.1.2	Logical_Address .....	81
7.1.3	Group_Address .....	82
7.2	Master Frames contents .....	82
7.2.1	Master Frame format .....	82
7.2.2	F_code encoding .....	82
7.3	Slave Frame contents .....	83
7.3.1	Slave Frame format .....	83
7.3.2	Size error .....	84
7.4	Telegram types .....	84
7.4.1	Process Data telegram .....	84
7.4.2	Message Data .....	85
7.4.3	Supervisory Data telegrams .....	86
8	Medium allocation .....	87
8.1	Organisation .....	87
8.1.1	Turn .....	87
8.1.2	Basic Period .....	87
8.1.3	Padding .....	88
8.2	Periodic Polling .....	88
8.2.1	Periodic List .....	88
8.2.2	Individual Period .....	88
8.2.3	Periodic Phase construction .....	89
8.3	Event Polling .....	90
8.3.1	Group_Address .....	90
8.3.2	Event_Round .....	91
8.3.3	Recommended event search algorithm .....	93
8.3.4	Supervisory Data frames for Event_Arbitration .....	94
8.4	Devices_Scan .....	96
8.4.1	Device_Status .....	96
8.4.2	Device_Status protocol .....	98
8.4.3	Devices_Scan protocol .....	99
9	Mastership transfer .....	99
9.1	Mastership transfer operation .....	99
9.1.1	Bus administrator configuration .....	99
9.2	Mastership transfer specifications .....	100
9.2.1	States .....	100
9.2.2	Time-outs for mastership transfer .....	103
9.3	Supervisory data frames for mastership transfer .....	103
9.3.1	Device_Status telegram .....	103
9.3.2	Mastership transfer telegram .....	104
10	Link Layer Interface .....	104
10.1	Link Layer layering .....	104

10.2	Link Process Data interface .....	105
10.3	Link Message Data interface.....	105
10.3.1	General .....	105
10.3.2	Priority.....	106
10.3.3	Packet size .....	106
10.3.4	Protocol_Type.....	106
10.3.5	Message Transport Protocol .....	106
10.4	Link Supervision Interface.....	106
10.4.1	General .....	106
10.4.2	Link Supervision Interface procedures.....	106
10.4.3	MVB_Status.....	107
10.4.4	MVB_Control .....	107
10.4.5	MVB_Devices .....	108
10.4.6	MVB_Administrator .....	108
10.4.7	MVB_Report .....	110
11	Real-Time Protocols .....	111
12	Gateway Function .....	111
13	Network Management .....	111
13.1	Contents of this clause .....	111
13.2	MVB Managed objects.....	111
13.2.1	MVB link objects .....	111
13.3	MVB Services and management messages.....	112
13.3.1	MVB link services .....	112
	Bibliography .....	126
	Figure 1 – Reference device and structure of the document.....	11
	Figure 2 – State transition example .....	37
	Figure 3 – MVB configuration .....	39
	Figure 4 – Transceiver interface .....	42
	Figure 5 – Example of ESD segment .....	43
	Figure 6 – Example of terminator.....	44
	Figure 7 – ESD backplane section (double-line).....	46
	Figure 8 – ESD connector arrangement.....	47
	Figure 9 – ESD terminator connector arrangement .....	48
	Figure 10 – Example of start of frame (ESD) .....	49
	Figure 11 – End of an ESD frame (both cases).....	50
	Figure 12 – EMD medium .....	51
	Figure 13 – Shielding (single-line segment) .....	53
	Figure 14 – Single-line device attachment .....	54
	Figure 15 – Double-line device attachment to EMD .....	55
	Figure 16 – EMD connectors arrangement.....	56
	Figure 17 – EMD terminator strapping .....	57
	Figure 18 – Example of start of an EMD frame .....	58
	Figure 19 – Example of pulse waveform at EMD transmitter .....	60
	Figure 20 – Example of end of EMD frame .....	61
	Figure 21 – EMD receiver test signal .....	62

Figure 22 – Optical link .....	64
Figure 23 – Optical connector (dimensions in millimeters).....	65
Figure 24 – Example of start of OGF frame .....	66
Figure 25 – Edge jitter .....	67
Figure 26 – Example of active star coupler .....	67
Figure 27 – Example of a duplicated star coupler.....	68
Figure 28 – "0" and "1" data encoding.....	69
Figure 29 – Non_Data symbols encoding.....	69
Figure 30 – Master Start Delimiter .....	70
Figure 31 – Slave Start Delimiter .....	70
Figure 32 – Example of End Delimiter for EMD medium.....	70
Figure 33 – Example of a valid frame (OGF medium).....	71
Figure 34 – Signal skew .....	72
Figure 35 – Example of repeater for single-line attachment.....	74
Figure 36 – Example of repeater connecting a double-line to a single line segment.....	75
Figure 37 – Master Frame Format .....	75
Figure 38 – Slave Frames .....	76
Figure 39 – Telegram timing.....	77
Figure 40 – Example of Reply delay.....	78
Figure 41 – Frame spacing at the source side.....	79
Figure 42 – Frame spacing at the destination(s) .....	79
Figure 43 – Frame spacing at the master side.....	80
Figure 44 – Master Frame contents.....	82
Figure 45 – Word ordering in a Slave Frame.....	84
Figure 46 – Process Data telegram .....	84
Figure 47 – Message Data telegram .....	85
Figure 48 – Supervisory Data telegram.....	86
Figure 49 – Basic Periods .....	87
Figure 50 – Example of construction of the Macro_Cycle .....	90
Figure 51 – General_Event_Request frame format .....	94
Figure 52 – Group_Event_Request frame (M = 6, C = ABCDEF).....	94
Figure 53 – Single_Event_Request frame.....	95
Figure 54 – Event_Identifier_Response frame .....	95
Figure 55 – Device_Status_Request.....	96
Figure 56 – Device_Status_Response .....	96
Figure 57 – Device_Status of Class 1 device .....	97
Figure 58 – Device_Status of Class 2/3/4/5 device .....	97
Figure 59 – Device_Status of a device with Bus Administrator capability.....	97
Figure 60 – Device_Status of a device with Gateway capability .....	98
Figure 61 – Mastership Transfer states .....	102
Figure 62 – Device_Status_Request (sent by current master) .....	103
Figure 63 – Device_Status_Response (sent by proposed master).....	103
Figure 64 – Mastership_Transfer_Request (sent by current master).....	104

Figure 65 – Mastership_Transfer_Response (sent by proposed next master) .....	104
Figure 66 – Link Layer Layering.....	105
Table 1 – Template for the specification of an interface procedure .....	34
Table 2 – Example of message structure .....	35
Table 3 – Example of textual message form (corresponding to Table 2).....	36
Table 4 – State transitions table .....	37
Table 5 – MVB devices capabilities .....	40
Table 6 – Pin assignment for the ESD connector .....	47
Table 7 – Pin assignment for the EMD connector.....	56
Table 8 – Master Frame types and F_code .....	83
Table 9 – LS_RESULT encoding .....	107
Table 10 – MVB_Status object .....	107
Table 11 – MVB_Control object .....	108
Table 12 – MVB_Devices object .....	108
Table 13 – MVB_Administrator object.....	109
Table 14 – LS_V_REPORT encoding.....	111
Table 15 – Example of myb_administrator_list.....	123

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